

## Surface Mount ESD Capability Rectifiers

**SlimSMA**

**Top View**
**Bottom View**
**DO-221AC**

### PRIMARY CHARACTERISTICS

|                                          |                            |
|------------------------------------------|----------------------------|
| $I_{F(AV)}$                              | 3.0 A                      |
| $V_{RRM}$                                | 100 V, 200 V, 400 V, 600 V |
| $I_{FSM}$                                | 40 A                       |
| $V_F$ at $I_F = 3.0$ A ( $T_A = 125$ °C) | 0.86 V                     |
| $I_R$                                    | 10 $\mu$ A                 |
| $T_J$ max.                               | 175 °C                     |
| Package                                  | DO-221AC (SlimSMA)         |
| Diode variations                         | Single die                 |

### TYPICAL APPLICATIONS

General purpose, power line polarity protection, in both consumer and automotive applications.

### FEATURES

- Very low profile - typical height of 0.95 mm
- Ideal for automated placement
- Oxide planar chip junction
- Low forward voltage drop, low leakage current
- ESD capability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)



**RoHS**  
COMPLIANT  
HALOGEN  
**FREE**

### MECHANICAL DATA

**Case:** DO-221AC (SlimSMA)

Molding compound meets UL 94 V-0 flammability rating  
Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

Base P/NHM3 - halogen-free, RoHS-compliant, and AEC-Q101 qualified

**Terminals:** Matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 suffix meets JESD 201 class 2 whisker test, HM3 suffix meets JESD 201 class 2 whisker test

**Polarity:** Color band denotes the cathode end

### MAXIMUM RATINGS ( $T_A = 25$ °C unless otherwise noted)

| PARAMETER                                                                         | SYMBOL         | SE30AFB     | SE30AFD | SE30AFG | SE30AFJ | UNIT |
|-----------------------------------------------------------------------------------|----------------|-------------|---------|---------|---------|------|
| Device marking code                                                               |                | S3B         | S3D     | S3G     | S3J     |      |
| Maximum repetitive peak reverse voltage                                           | $V_{RRM}$      | 100         | 200     | 400     | 600     | V    |
| Maximum DC forward current                                                        | $I_F^{(1)}$    | 3.0         |         |         |         | A    |
|                                                                                   | $I_F^{(2)}$    | 1.4         |         |         |         |      |
| Peak forward surge current 10 ms single half sine-wave superimposed on rated load | $I_{FSM}$      | 40          |         |         |         | A    |
| Operating junction and storage temperature range                                  | $T_J, T_{STG}$ | -55 to +175 |         |         |         | °C   |

#### Notes

(1) Mounted on 15 mm x 15 mm pad areas, 2 oz. FR4 PCB

(2) Free air, mounted on recommended copper pad area

### ELECTRICAL CHARACTERISTICS ( $T_A = 25$ °C unless otherwise noted)

| PARAMETER                     | TEST CONDITIONS                                                          |                         | SYMBOL                        | TYP. | MAX. | UNIT |
|-------------------------------|--------------------------------------------------------------------------|-------------------------|-------------------------------|------|------|------|
| Instantaneous forward voltage | I <sub>F</sub> = 1.5 A                                                   | T <sub>A</sub> = 25 °C  | V <sub>F</sub> <sup>(1)</sup> | 0.91 | -    | V    |
|                               | I <sub>F</sub> = 3.0 A                                                   |                         |                               | 0.97 | 1.1  |      |
|                               | I <sub>F</sub> = 1.5 A                                                   | T <sub>A</sub> = 125 °C |                               | 0.79 | -    |      |
|                               | I <sub>F</sub> = 3.0 A                                                   |                         |                               | 0.86 | 0.98 |      |
| Reverse current               | Rated V <sub>R</sub>                                                     | T <sub>A</sub> = 25 °C  | I <sub>R</sub> <sup>(2)</sup> | -    | 10   | μA   |
|                               |                                                                          | T <sub>A</sub> = 125 °C |                               | 13   | 100  |      |
| Typical reverse recovery time | I <sub>F</sub> = 0.5 A, I <sub>R</sub> = 1.0 A, I <sub>rr</sub> = 0.25 A |                         | t <sub>rr</sub>               | 1.5  | -    | μs   |
| Typical junction capacitance  | 4.0 V, 1 MHz                                                             |                         | C <sub>J</sub>                | 19   | -    | pF   |

#### Notes

(1) Pulse test: 300  $\mu$ s pulse width, 1 % duty cycle

(2) Pulse test: Pulse width  $\leq$  40 ms

**THERMAL CHARACTERISTICS** ( $T_A = 25\text{ }^{\circ}\text{C}$  unless otherwise noted)

| PARAMETER                  | SYMBOL                          | SE30AFB | SE30AFD | SE30AFG | SE30AFJ | UNIT |
|----------------------------|---------------------------------|---------|---------|---------|---------|------|
| Typical thermal resistance | R <sub>θJA</sub> <sup>(1)</sup> | 125     |         |         |         | °C/W |
|                            | R <sub>θJM</sub> <sup>(2)</sup> | 12      |         |         |         |      |

**Notes**

- (1) Free air, mounted on recommended PCB, 1 oz. pad area; thermal resistance  $R_{\theta JA}$  - junction to ambient  
 (2) Mounted on 15 mm x 15 mm pad areas, 2 oz. FR4 PCB;  $R_{\theta JM}$  - junction to mount

**IMMUNITY TO ELECTRICAL STATIC DISCHARGE TO THE FOLLOWING STANDARDS**( $T_A = 25\text{ }^{\circ}\text{C}$  unless otherwise noted)

| STANDARD     | TEST TYPE                       | TEST CONDITIONS                                | SYMBOL | CLASS | VALUE           |
|--------------|---------------------------------|------------------------------------------------|--------|-------|-----------------|
| AEC-Q101-001 | Human body model (contact mode) | $C = 100\text{ pF}$ , $R = 1.5\text{ k}\Omega$ | $V_C$  | H3B   | $> 8\text{ kV}$ |

**ORDERING INFORMATION** (Example)

| PREFERRED P/N                | UNIT WEIGHT (g) | PREFERRED PACKAGE CODE | BASE QUANTITY | DELIVERY MODE                      |
|------------------------------|-----------------|------------------------|---------------|------------------------------------|
| SE30AFJ-M3/6A                | 0.032           | 6A                     | 3500          | 7" diameter plastic tape and reel  |
| SE30AFJ-M3/6B                | 0.032           | 6B                     | 14 000        | 13" diameter plastic tape and reel |
| SE30AFJHM3/6A <sup>(1)</sup> | 0.032           | 6A                     | 3500          | 7" diameter plastic tape and reel  |
| SE30AFJHM3/6B <sup>(1)</sup> | 0.032           | 6B                     | 14 000        | 13" diameter plastic tape and reel |

**Note**

- (1) AEC-Q101 qualified

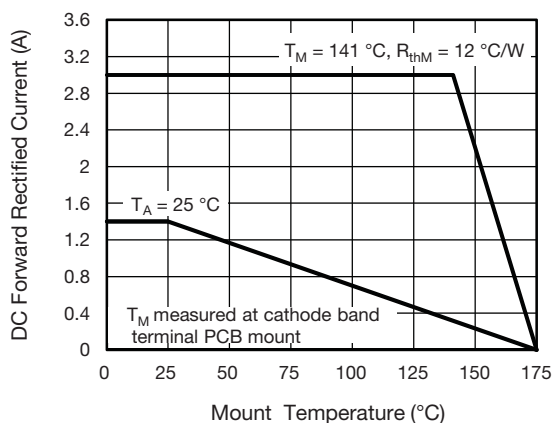
**RATINGS AND CHARACTERISTICS CURVES** ( $T_A = 25\text{ }^{\circ}\text{C}$  unless otherwise noted)

Fig. 1 - Maximum Forward Current Derating Curve

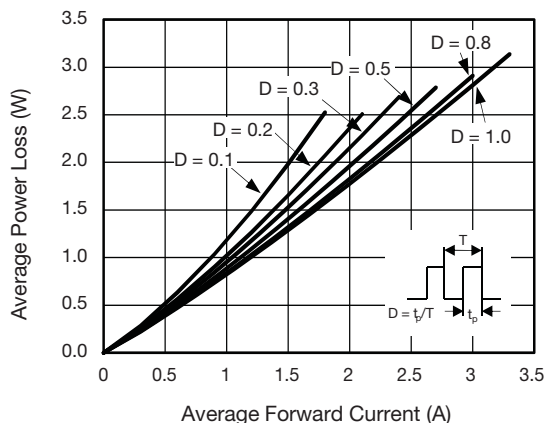
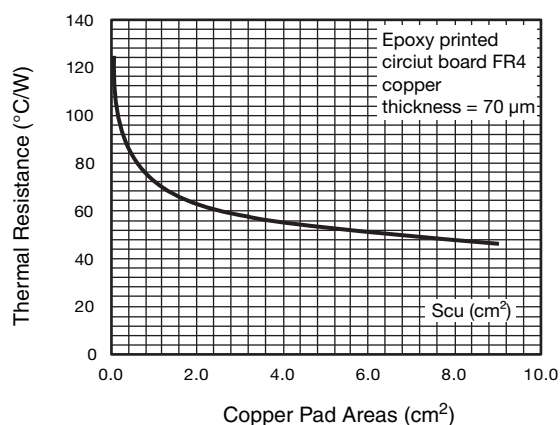
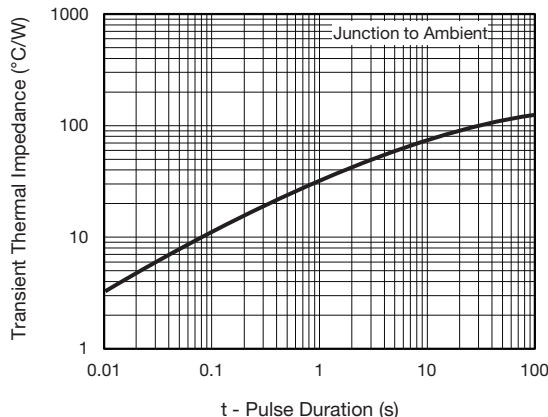
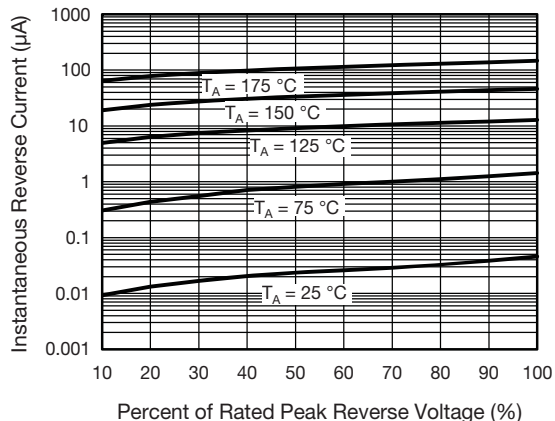
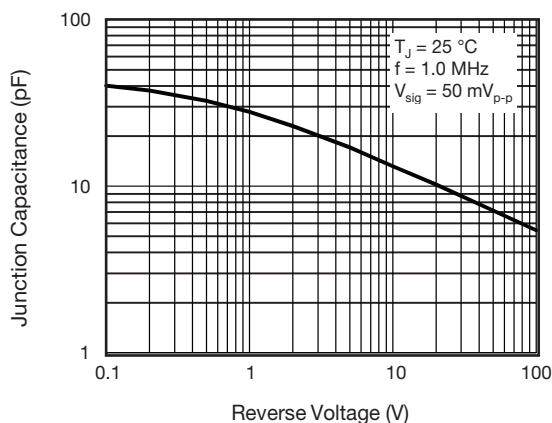
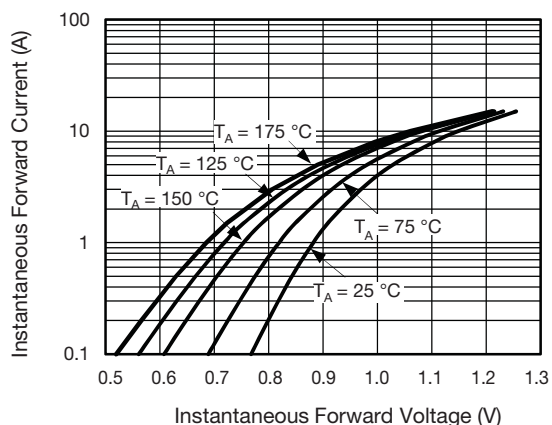


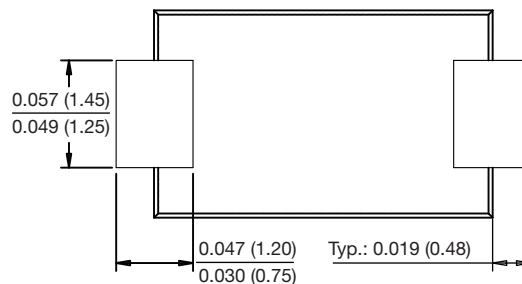
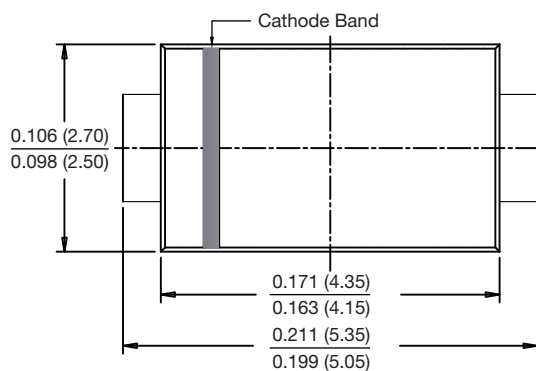
Fig. 2 - Forward Power Loss Characteristics



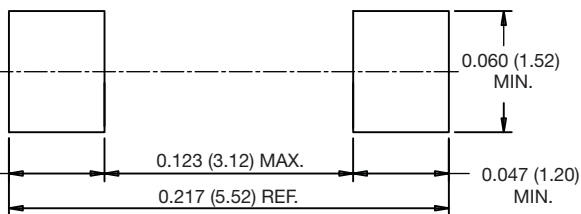
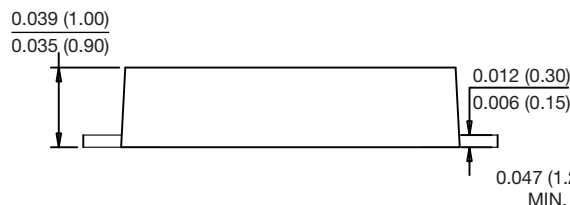


## PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

### DO-221AC (SlimSMA)



### Mounting Pad Layout





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